

AMENDMENT TRANSMITTAL LETTER (Large Entity)Applicant(s): **Burrell et al.**

Docket No.

FIS920000242US1Application No.
09/805,027Filing Date
03/12/2001Examiner
M. LewisCustomer No.
30743Group Art Unit
2822Confirmation No.
1563

Invention:

COPPER TO ALUMINUM INTERLAYER INTERCONNECT USING STUD AND VIA LINER**COMMISSIONER FOR PATENTS:**

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	8 -	20 =	0	x \$50.00	\$0.00
INDEP. CLAIMS	2 -	3 =	0	x \$200.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
- ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account **09-0458**
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Marshall M. Curtis
Signature

Dated: **February 3, 2006****Marshall M. Curtis**
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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on

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FIS920000242US1 (00750429AA)

PATENT APPLICATION

1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Lloyd G. Burrell et al.

Serial No.: 09/805,027

Group Art Unit: 2822

Filed: March 12, 2001

Examiner: M. Lewis

For: COPPER TO ALUMINUM INTERLAYER INTERCONNECT USING
STUD AND VIA LINER

Commissioner for Patents
United States Patent and Trademark Office
P. O. Box 1450
Alexandria, Virginia 22313-1450

AMENDMENT UNDER 37 C. F. R. §1.111

Sir:

In response to the Office Action mailed November
3, 2005, please amend the above-identified application
as follows:

No amendments to the specification are
presented in this paper.

Amendments to the claims begin on page 2 of
this paper.

Remarks begin on page 5 of this paper.